# KIOXIA

# >HK4E SERIES ENTERPRISE SATA SSD

Specifically engineered for value-endurance workloads, the HK4E eSSD delivers high reliability, high performance and low power usage. Data center and enterprise applications benefit from the excellent quality of service, provided by the series.

The 7.0mm height drive is available in high capacities up to 1.6TB and supports 6.0 Gbit/s SATA interface. Each model is provided with enterprise-class features such as Power Loss Protection.



#### KEY FEATURES

- Capacities up to 1.6 TB
- SATA 6.0 Gbit/s Interface
- 3 DWPD
- · Low Operating Power
- Power Loss Protection
- End to end data protection
- Hot-Plug/OS-Aware Hot Removal

#### > APPLICATIONS

- OLTP
- VDI
- Data center
- Database
- E-Commerce
- E-Mail/Messaging Server

#### > SPECIFICATIONS

Standard Models	2.5-inch (7.0mmH)	
Connector Type	Standard SATA	
Memory	KIOXIA MLC NAND Flash Memory	
Interface 1)	ACS-3, SATA revision 3.2, 1.5/3/6 Gbit/s	
Capacity 1)	200/400/800/1600 GB	
Performance 1) 2) 3)	Sequential Read: 524 MB/s{500 MiB/s} Sequential Write: 503 MB/s{480 MiB/s} Random Read: 75,000 IOPS Random Write: 30,000 IOPS	
Supply Voltage	5.0 V ±5 %	
Power Consumption	Active: 4.5 W typ. Idle: 1.2 W typ.	
Temperature	Operating: 0 °C - 55 °C  Non-operating: -40 °C - 70 °C	
Shock	Operating / Non-operating: 9,800 m/s² {1000 G} at 0.5 ms	
Vibration	Operating: 21 m/s² {2.17 Grms} at 100-800 Hz Non-operating: 159 m/s² {16.3 Grms} at 20-2,000 Hz	
Reliability	Mean Time to Failure (MTTF): 2,000,000 hours  Product Life: Approximately 5 years	
Size	100.45 mm(Length) x 69.85 mm(Width) x 7.0 mm(Height)	
Weight	60 g Max	
More Features	28-bit LBA mode commands and 48-bit LBA mode commands support Automatic retries and corrections for read errors NCQ (Native Command Queuing) function supported	
Compliance	UL, cUL(CSA), TÜV, KC, FCC, BSMI, CE, RCM, ISED, VCCI	

Refer to the notes on the next page.

# KIOXIA

- Definition of capacity: KIOXIA defines a megabyte (MB) as 1,000,000 bytes, a gigabyte (GB) as 1,000,000,000,000 bytes and a terabyte (TB) as 1,000,000,000,000 bytes. A computer operating system, however, reports storage capacity using powers of 2 for the definition of 1GB = 2<sup>30</sup> = 1,073,741,824 bytes and therefore shows less storage capacity. Available storage capacity (including examples of various media files) will vary based on file size, formatting, settings, software and operating system, such as Microsoft Operating System and/or pre-installed software applications, or media content. Actual formatted capacity may vary.
- 2) A kibibyte (KiB) means 2<sup>10</sup>, or 1,024 bytes, a mebibyte (MiB) means 2<sup>20</sup>, or 1,048,576 bytes, and a gibibyte (GiB) means 2<sup>30</sup>, or 1,073,471,824 bytes.
- 3) Performances are measured when the SSD is on a steady state.
- \* MTTF (Mean Time to Failure) is not a guarantee or estimate of product life; it is a statistical value related to mean failure rates for a large number of products which may not accurately reflect actual operation. Actual operating life of the product may be different from the MTTF.
- \* DWPD: Drive Write Per Day. One full drive write per day means the drive can be written and re-written to full capacity once a day every day for five years, the stated product warranty period. Actual results may vary due to system configuration, usage and other factors.
- \* Read and write speed may vary depending on the host device, read and write conditions, and file size.
- \* IOPS: Input Output Per Second (or the number of I/O operations per second)
- \* PLP (Power Loss Protection): PLP supports to record data in buffer memory to NAND flash memory, utilizing back up power of solid capacitor in case of sudden supply shut down.



# ORDERING INFORMATION

THN SN 8 xxxx C S E 1 2 3 4 5 6 7

1. Model Name THN: KIOXIA NAND drive

2. Model Type SN: SED not supported

3. Controller Type 8: Type 8

4. Capacity 200P/400P/800P/1Q60: 200GB/400GB/800GB/1600GB with PLP

(1 GB = 1,000,000,000 bytes)

5. Form Factor C: 2.5-inch case (7.0 mm height)

6. Host I/F Type S: Standard SATA

7. NAND Type E: MLC



# PRODUCT LINE UP

Model Number	Formatted Capacity	PLP <sup>1)</sup>	SED <sup>2)</sup>	Form Factor
THNSN8200PCSE	200 GB	Supported	Not supported	
THNSN8400PCSE	400 GB	Supported	Not supported	2.5-inch 7.0 mm case
THNSN8800PCSE	800 GB	Supported	Not supported	
THNSN81Q60CSE	1600GB	Supported	Not supported	

<sup>1)</sup> PLP: Power Loss Protection

#### **CAPACITY**

Capacity	Total Number of User Addressable Sectors in LBA Mode 512 bytes sector	
200 GB	390,721,968	
400 GB	781,422,768	
800 GB	1,562,824,368	
1600 GB	3,125,627,568	

Note: 1 GB (Gigabyte) = 1,000,000,000 bytes

# PERFORMANCE

	THNSN81Q60CSE	THNSN8800PCSE	THNSN8400PCSE	THNSN8200PCSE
Interface Speed	6 Gbit/s Max			
Sequential Read 64KiB, QD=32	524 MB/s {500 MiB/s}			
Sequential Write 64KiB, QD=32	503 MB/s 283 MB/s {480 MiB/s} {270 MiB/s}			
Random Read 4KiB, QD=32	75,000 IOPS			
Random Write 4KiB, QD=32		30,000 IOPS		20,000 IOPS

Note: Performances are measured when the SSD is on a typical steady state.

<sup>2)</sup> SED: Self Encrypting Drive based on TCG Enterprise SSC



# SUPPLY VOLTAGE

	2.5-inch Case(7.0 mmH)
Allowable voltage	5.0 V ±5 %
Allowable noise/ripple	250 mV p-p or less

Note: This drive has over current protection circuit. (Rated current: 3.15A)

#### POWER CONSUMPTION

Operation (Ta <sup>1)</sup> =25°C)	2.5-inch Case(7.0 mmH)
Active	4.5 W typ.
Idle	1.2 W typ.

<sup>1)</sup> Ambient Temperature

# **ENVIRONMENTAL CONDITIONS**

#### TEMPERATURE

Condition	Range	Gradient
Operating (Ta) 1)	0 °C – 55 °C	20 °C/h Max
Non-operating (Ta) 1)	-40 °C – 70 °C	20 °C/h Max
Under Shipment (Ta) 1) 2)	-40 °C – 70 °C	20 °C/h Max

<sup>1)</sup> Ta: Ambient Temperature, Tc: Case or Components Temperature

# > HUMIDITY

Condition	Range	
Operating	5 % – 95 % R.H. (No condensation)	
Non-operating	5 % – 95 % R.H. (No condensation)	
Under Shipment 1)	5 % – 95 % R.H.	

<sup>1)</sup> Packaged in KIOXIA's original shipping package

# SHOCK

Condition	Range
Operating	
Non-operating	9,800 m/s $^2$ {1000 G} / 0.5 ms duration
Under Shipment 1)	

<sup>1)</sup> Apply shocks in each direction of the drive's three mutually perpendicular axes, one axis at a time. Packaged in KIOXIA's original shipping package.

<sup>2)</sup> Packaged in KIOXIA's original shipping package



# **>** VIBRATION

Condition	Range	
Operating	21 m/s <sup>2</sup> {2.17 Grms} (100 to 800 Hz)	
Non-Operating	159 m/s <sup>2</sup> {16.3 Grms} (20 to 2000 Hz)	
Under Shipment		

# **COMPLIANCE**

# > SAFETY / EMI STANDARDS

Title	Description	Region
UL (Underwriters Laboratories)	UL 60950-1	USA
cUL(CSA) (Underwriters Laboratories of Canada (Canadian Standard Association))	CSA-C22.2 No.60950-1	Canada
TÜV (Technischer Überwachungs Verein)	EN 60950-1	Germany
KC	KN22, KN24	Korea
FCC	FCC part 15 Subpart B Class B	USA
BSMI (Bureau of Standards, Metrology and Inspection)	CNS13438(CISPR Pub. 22) Class B	Taiwan
CE	EN 55022, EN 55024	Europe
RCM	AS/NZS CISPR Pub. 22 Class B	Australia, New Zealand
ISED	ICES-003	Canada
VCCI	Class B	Japan

# RELIABILITY

Parameter	Value
Mean Time to Failure	2,000,000 hours
Product Life	Approximately 5 years



# **MECHANICAL SPECIFICATIONS**

# > 2.5-inch

Model	Weight	Width	Height	Length	
THNSN8200PCSE	60 g Max	69.85 mm +/- 0.25 mm	7.0 mm + 0.2, -0.5 mm	100.45 mm Max	
THNSN8400PCSE					
THNSN8800PCSE					
THNSN81Q60CSE					

The enclosure of this device complies with SFF-8201 Rev.3.2.

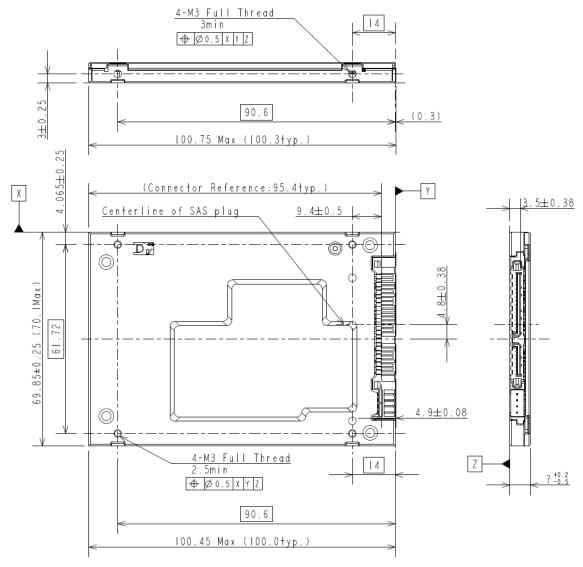


Figure 1: 2.5-inch Drive Dimension



#### INTERFACE CONNECTOR

# 2.5-inchSATA Interface Connector

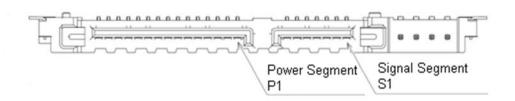


Figure 2: 2.5-inch SATA Interface connector

#### 2.5-INCH DRIVE CONNECTER PIN ASSIGNMENT

Segment	Pin Position	Name	Signal Description		
	S1	GND	Ground		
	S2	A+	Differential Pair A		
0: 1	S3	A-			
Signal Segment	S4	GND	Ground		
ocginent	S5	B-	Differential Pair B		
	S6	B+			
	S7	GND	Ground		
		Signal	segment "L"		
	Central connector polarizer				
Power segment "L"					
	P1	V33	3.3 V power (Unused) 1) 2)		
	P2	V33	3.3 V Power (Unused) 1) 2)		
	P3	V33	3.3 V power pre-charge (Unused) 1)		
	P4	GND	Ground		
	P5	GND	Ground		
	P6	GND	Ground		
Power	P7	V5	5 V power, pre-charge		
Segment	P8	V5	5 V power		
oog.non.	P9	V5	5 V power		
	P10	GND	Ground		
	P11	DAS/DSS	Drive Active Signal / Disable Staggered Spin-up 3)		
	P12	GND	Ground		
	P13	V12	12 V power, pre-charge (Unused)		
	P14	V12	12 V power (Unused)		
	P15	V12	12 V power (Unused)		
		Power	segment key		

<sup>1)</sup> This drive uses 5V power. 12V and 3.3V power are not used. DE and DC ground (ground pins on interface) are connected electrically each other.

<sup>2)</sup> P1 and P2 are connected together.

<sup>3)</sup> DSS is not supported.



# COMMAND TABLE

#### ATA Command Set

ATA Command Set			
Op-Code	Command Name		
00h	NOP		
06h	DATA SET MANAGEMENT		
10h	RECALIBRATE		
20h	READ SECTOR(S)		
21h	READ SECTOR(S) WITHOUT RETRY		
24h	READ SECTOR(S) EXT		
25h	READ DMA EXT		
27h	READ NATIVE MAX ADDRESS EXT		
29h	READ MULTIPLE EXT		
2Fh	READ LOG EXT		
30h	WRITE SECTOR(S)		
31h	WRITE SECTOR(S) WITHOUT RETRY		
34h	WRITE SECTOR(S) EXT		
35h	WRITE DMA EXT		
37h	SET MAX ADDRESS EXT		
39h	WRITE MULTIPLE EXT		
3Dh	WRITE DMA FUA EXT		
3Fh	WRITE LOG EXT		
40h	READ VERIFY SECTOR(S)		
41h	READ VERIFY SECTOR(S) WITHOUT RETRY		
42h	READ VERIFY SECTOR(S) EXT		
45h	WRITE UNCORRECTABLE EXT		
45h 55h	Create a pseudo-uncorrectable error with logging		
45h AAh	Create a flagged error without logging		
47h	READ LOG DMA EXT		
57h	WRITE LOG DMA EXT		
60h	READ FPDMA QUEUED		
61h	WRITE FPDMA QUEUED		
70h	SEEK		
90h	EXECUTE DEVICE DIAGNOSTIC		
91h	INITIALIZE DEVICE PARAMETERS		



Op-Code		Command Name	
92h		DOWNLOAD MICROCODE	
92h	03h	Download with offsets and save microcode for immediate and future use.	
92h	07h	Download and save microcode for immediate and future use.	
92h	0Eh	Download with offsets and save microcode for future use.	
92h	0Fh	Activate downloaded microcode.	
93	3h	DOWNLOAD MICROCODE DMA	
93h	03h	Download with offsets and save microcode for immediate and future use.	
93h	07h	Download and save microcode for immediate and future use.	
93h	0Eh	Download with offsets and save microcode for future use.	
93h	0Fh	Activate downloaded microcode	
BO	Oh	SMART	
B0h	D0h	SMART READ DATA	
B0h	D1h	SMART READ ATTRIBUTE THRESHOLDS	
B0h	D2h	SMART ENABLE/DISABLE ATTRIBUTE AUTOSAVE	
B0h	D3h	SMART SAVE ATTRIBUTE VALUES	
B0h	D4h	SMART EXECUTE OFF-LINE IMMEDIATE	
B0h	D5h	SMART READ LOG	
B0h	D6h	SMART WRITE LOG	
B0h	D8h	SMART ENABLE OPERATIONS	
B0h	D9h	SMART DISABLE OPERATIONS	
B0h	DAh	SMART RETURN STATUS	
B0h	DBh	SMART ENABLE/DISABLE AUTOMATIC OFF-LINE	
B <sup>2</sup>	1h	DEVICE CONFIGURATION OVERLAY	
B1h	C0h	DEVICE CONFIGURATION RESTORE	
B1h	C1h	DEVICE CONFIGURATION FREEZE LOCK	
B1h	C2h	DEVICE CONFIGURATION IDENTIFY	
B1h	C3h	DEVICE CONFIGURATION SET	
B1h	C4h	DEVICE CONFIGURATION IDENTIFY DMA	
B1h	C5h	DEVICE CONFIGURATION SET DMA	
B4h		SANITIZE DEVICE	
B4h	00h	SANITIZE STATUS EXT	
B4h	12h	BLOCK ERASE EXT	
B4h	20h	SANITIZE FREEZE LOCK EXT	
C4h		READ MULTIPLE	
C5h		WRITE MULTIPLE	
Ce	6h	SET MULTIPLE MODE	
C	3h	READ DMA	
C	9h	READ DMA WITHOUT RETRY	



	Op-Code		Command Name	
	CAh		WRITE DMA	
	CBh		WRITE DMA WITHOUT RETRY	
	CEh		WRITE MULTIPLE FUA EXT	
	E0h		STANDBY IMMEDIATE	
	E1h		IDLE IMMEDIATE	
	E2h		STANDBY	
	E3h		IDLE	
	E4h		READ BUFFER	
	E5h		CHECK POWER MODE	
	E6h		SLEEP	
	E7h		FLUSH CACHE	
	E8h		WRITE BUFFER	
	E9h		READ BUFFER DMA	
	EAh		FLUSH CACHE EXT	
	EBh		WRITE BUFFER DMA	
	ECh		IDENTIFY DEVICE	
	EFh		SET FEATURES	
EFh	02h		Enable volatile write cache	
EFh	03h		Set transfer mode	
EFh	05h		Enable APM feature set	
EFh	10h		Enable Serial ATA feature set	
EFh	10h	02h	Enable DMA Setup FIS Auto-Activate optimization	
EFh	10h	03h	Enable Device-initiated interface power state (DIPM) transitions	
EFh	10h	06h	Enable Software Settings Preservation(SSP)	
EFh	10h	07h	Enable Device Automatic Partial to Slumber transitions	
EFh	10h	09h	Enable Device Sleep	
EFh	55h		Disable read look-ahead	
EFh	66h		Disable reverting to power-on defaults	
EFh	82h		Disable volatile write cache	
EFh	85h		Disable APM feature set	
EFh	90h		Disable Serial ATA feature set	
EFh	90h	02h	Disable DMA Setup FIS Auto-Activate optimization	
EFh	90h	03h	Disable Device-initiated interface power state (DIPM) transitions	
EFh	90h	06h	Disable Software Settings Preservation(SSP)	
EFh	90h	07h	Disable Device Automatic Partial to Slumber transitions	
EFh	90h	09h	Disable Device Sleep	
EFh	AAh		Enable read look-ahead	
EFh	CCh		Enable reverting to power-on defaults	



Op-Code			Command Name	
	F1h		SECURITY SET PASSWORD	
	F2h		SECURITY UNLOCK	
	F3h		SECURITY ERASE PREPARE	
	F4h		SECURITY ERASE UNIT	
	F5h		SECURITY FREEZE LOCK	
	F6h		SECURITY DISABLE PASSWORD	
	F8h		READ NATIVE MAX ADDRESS	
	F9h		SET MAX ADDRESS	
F9h	01h		SET MAX SET PASSWORD	
F9h	02h		SET MAX LOCK	
F9h	03h		SET MAX UNLOCK	
F9h	04h		SET MAX FREEZE LOCK	
F9h	05h		SET MAX SET PASSWORD DMA	
F9h	06h		SET MAX UNLOCK DMA	



#### RESTRICTIONS ON PRODUCT USE

- KIOXIA Corporation, and its subsidiaries and affiliates (collectively "KIOXIA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from KIOXIA. Even with KIOXIA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though KIOXIA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant KIOXIA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "KIOXIA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. KIOXIA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY
  HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN
  LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE"). Except for specific
  applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment
  used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling
  equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and
  equipment used in finance-related fields. IF YOU USE PRODUCT FOR UNINTENDED USE, KIOXIA ASSUMES NO LIABILITY FOR
  PRODUCT. For details, please contact your KIOXIA sales representative.
- · Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by KIOXIA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR
  PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, KIOXIA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING
  WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT
  LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS
  ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION,
  INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF
  INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your KIOXIA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use
  Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without
  limitation, the EU RoHS Directive. KIOXIA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF
  NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.